

Small Signal Switching Chip Diode, Dual

Feature

Silicon Epitaxial Planar Diode.

Fast switching dual chip diode with anode to cathode.

This diode is also available in other configurations including single with type designation CDMMBD4148, a dual common anode with type designation CDBAV70, and a dual common cathode with type designation CDBAV99

Lead (Pd) - free component.

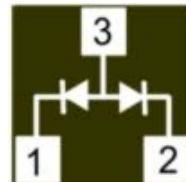
Figure



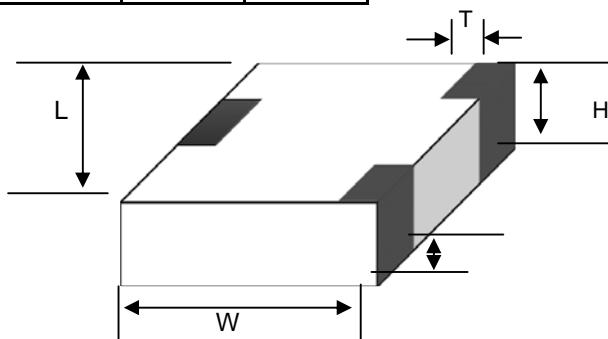
Case: SOT23 Plastic Case

Weight: approx. 21mg

Value: CDBAW56



| DIMENSION: | | | |
|------------|------------|------------|------------|
| (mm) | CDBAW56 | CDBAV70 | CDBAV99 |
| L | 3.1 ± 0.2 | 3.1 ± 0.2 | 3.1 ± 0.2 |
| W | 2.6 ± 0.2 | 2.6 ± 0.2 | 2.6 ± 0.2 |
| H | 0.95 ± 0.2 | 0.95 ± 0.2 | 0.95 ± 0.2 |
| T | 0.75 ± 0.2 | 0.75 ± 0.2 | 0.75 ± 0.2 |
| C | 0.8 ± 0.1 | 0.8 ± 0.1 | 0.8 ± 0.1 |



Maximum Ratings & Electrical Characteristics $T_{amb} = 25^{\circ}\text{C}$, unless otherwise noted

| Parameter | Symbol | Value | Unit |
|--|-----------------|----------------------------|--------------------|
| Device marking code | | CDBAW56 | |
| Non repetitive peak reverse voltage | V_{RM} | 100 | V |
| Repetitive peak reverse voltage | $V_R = V_{RRM}$ | 70 | V |
| Forward continuous current | I_F | 200 | mA |
| tp = 1 us | | 2.0 | |
| Non repetitive peak forward current tp = 1 ms | I_{FSM} | 1.0 | A |
| tp = 1 s | | 0.5 | |
| Average forward current | I_{FSM} | 150 ¹⁾ | mA |
| Power dissipation | P_{TOT} | 300 ¹⁾ | mW |
| Forward voltage | V_F | 715 855 1000 1250 | mV |
| Leakage current | I_R | 2.5 50 30 | μA |
| Thermal resistance junction to ambient air | R_{thJA} | 430 ¹⁾ | K/W |
| Junction temperature | T_j | 150 | $^{\circ}\text{C}$ |
| Storage temperature range | T_{stg} | - 55 to + 150 | $^{\circ}\text{C}$ |
| Diode capacitance ($V_F = V_R = 0$, f = 1MHz) | C_{tot} | 2 | pF |
| Reverse Recovery time ($I_F = 10\text{mA}$ to $I_R = 1\text{mA}$, $V_R = 6\text{V}$, $R_L = 100\Omega$) | T_{rr} | 6 | ns |

¹⁾ Valid provided that electrodes are kept at ambient temperature.



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Quality Commitment

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Typical Characteristics

(T_{amb}=25°C, unless otherwise specified)

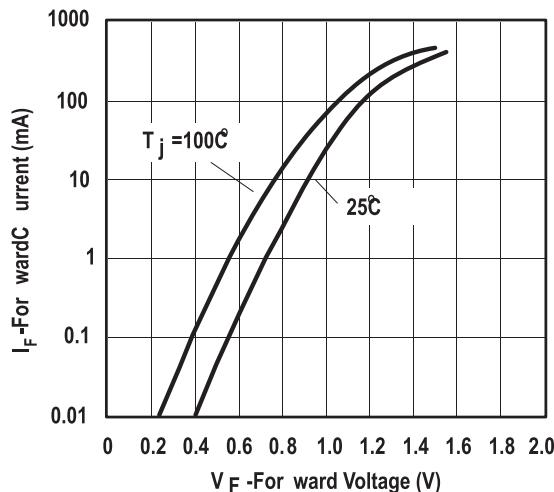


Figure 1. Forward Current vs. Forward Voltage

Value:CDBAW56

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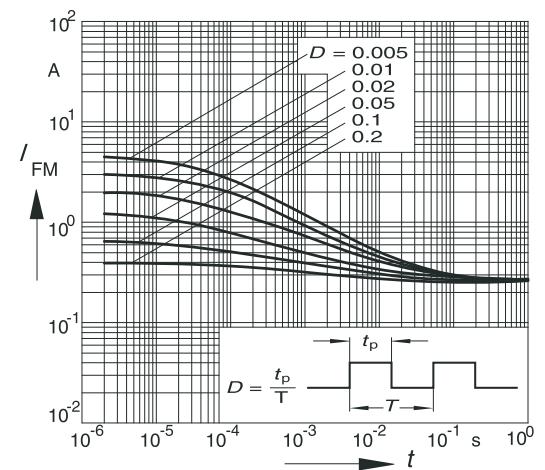
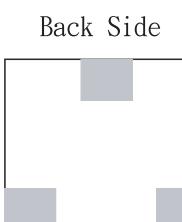
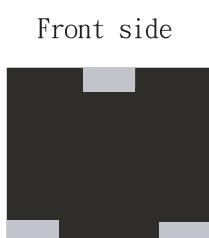
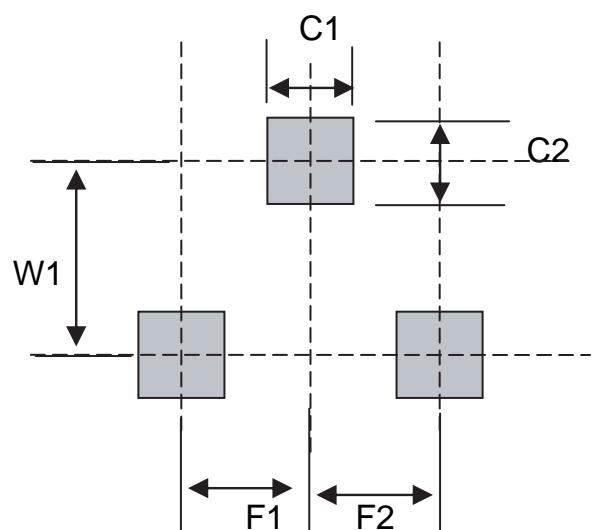


Figure 2. Peak forward current $I_{FM} = f(t_p)$

Device outlook



Mounting Pad Layout



| Mounting Pad Layout | | | |
|---------------------|---------|---------|---------|
| Typ.(mm) | CDBAW56 | CDBAV70 | CDBAV99 |
| W1 | 2.0 | 2.0 | 2.0 |
| C1 | 0.9 | 0.9 | 0.9 |
| C2 | 0.9 | 0.9 | 0.9 |
| F1 | 1.14 | 1.14 | 1.14 |
| F2 | 1.14 | 1.14 | 1.14 |



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Suggested thermal profiles for soldering processes

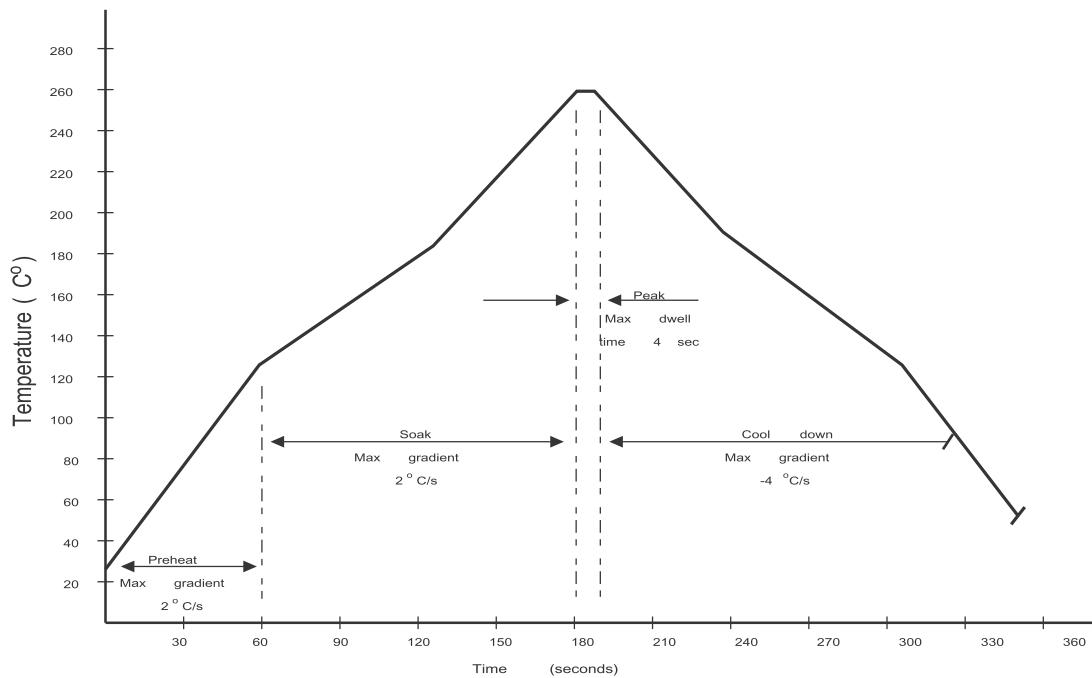


Fig.1 Typical Wave Soldering Thermal Profile

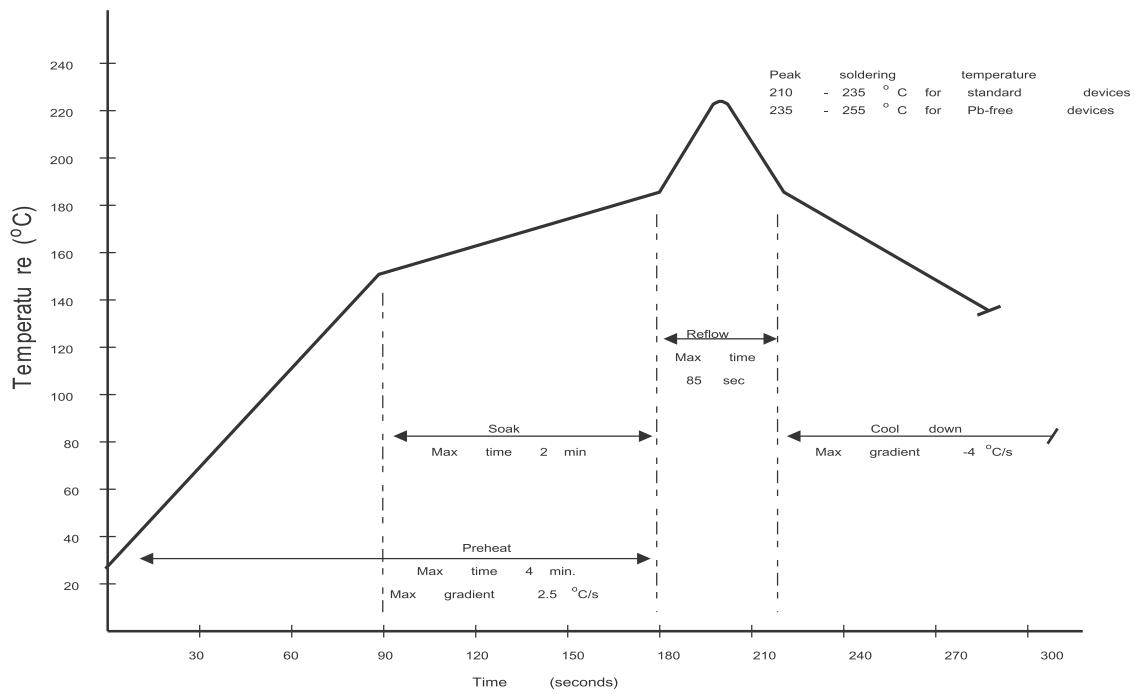


Fig.2 Typical IR Reflow Soldering Thermal Profile



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